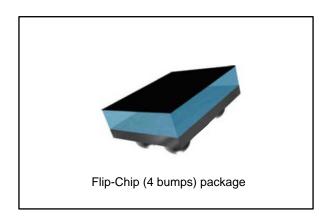
BALF-NRG-01D3



50 ohm nominal input / conjugate match balun balun to BlueNRG tranceiver, with integrated harmonic filter

Datasheet - production data



Features

- 50 Ω nominal input / conjugate match to BlueNRG device
- Low insertion loss
- Low amplitude imbalance
- Low phase imbalance
- Wafer level chip scale package (WLCSP)

Benefits

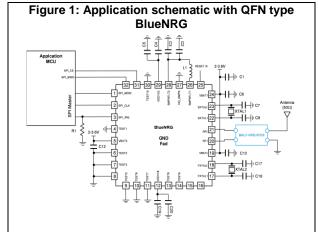
- Very low profile < 670 μm
- High RF performance
- RF BOM reduction
- Small footprint

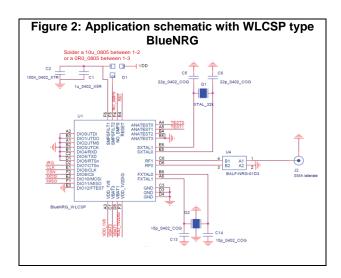
Applications

- Bluetooth low energy impedance matched balun filter
- Optimized for ST BlueNRG RFIC

Description

STMicroelectronics BALF-NRG-01D3 is an ultra miniature balun. The BALF-NRG-01D3 integrates matching network and harmonics filter. Matching impedance has been customized for the BlueNRG ST transceiver (both QFN and WLCSP versions). It is using STMicroelectronics IPD technology on non conductive glass substrate which optimizes RF performance.





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Characteristics BALF-NRG-01D3

1 Characteristics

Table 1: Absolute maximum ratings (limiting values)

Symbol	Doromotor		Value		
	Parameter	Min.	Тур.	Max.	Unit
Pin	Input power RFIN		-	20	dBm
V	ESD ratings MIL STD883C (HBM: C = 100 pF, R = 1.5 Ω , air discharge)	2000	-		\ \
V _{ESD}	ESD ratings machine model (MM: C = 200 pF, R = 25 W, L = 500 nH)	200	-		
Top	Operating temperature	-40	-	+105	°C

Table 2: Impedances (T_{amb} = 25 °C)

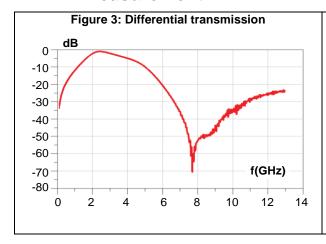
Symbol	Parameter		Value			
Symbol	Parameter	Min.	Тур.	Max.	Unit	
Z _{OUT}	Nominal differential output impedance	-	Match to BlueNRG	-	Ω	
Z _{IN}	Nominal input impedance	1	50	•	Ω	

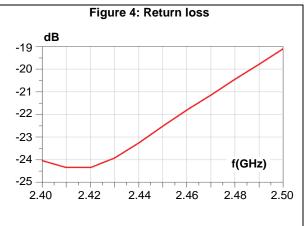
Table 3: RF performance (T_{amb} = 25 °C)

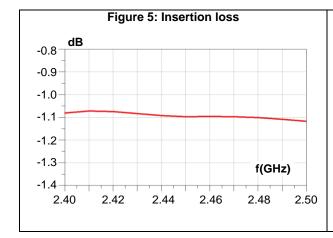
Cumbal	Dovementor	Took condition	Value			1111	
Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit	
f	Frequency range (bandwidth)		2400		2500	MHz	
S ₁₁	Input return loss bandwidth			-20		dB	
S ₂₁	Insertion loss			-1.1		dB	
		H2		-8		4D	
S ₂₁	Llaurania vaisatian (differential mada)	H3		-38			
	Harmonic rejection (differential mode)	H4	-31	dB			
		H5		-23			
ф imb	Output phase imbalance			7		o	
A _{imb}	Output amplitude imbalance			0.5		dB	

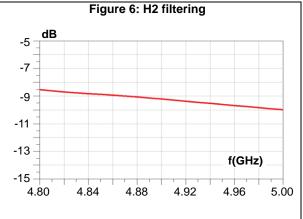
BALF-NRG-01D3 Characteristics

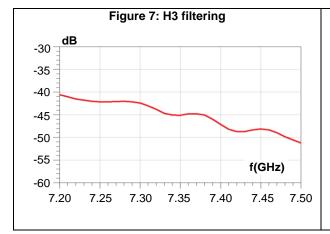
1.1 RF measurement

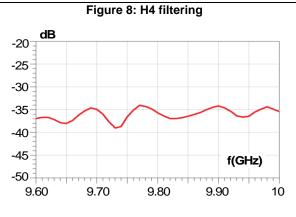




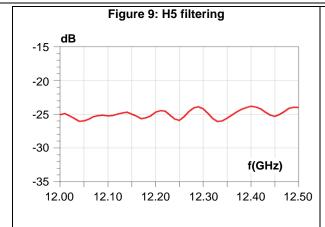


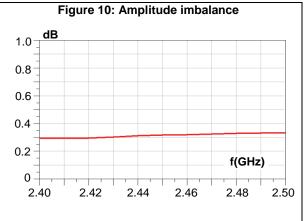


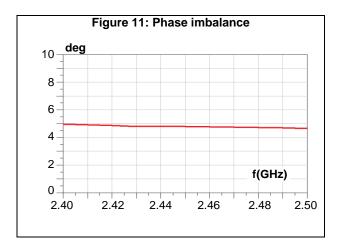




Characteristics BALF-NRG-01D3







2 BALF-NRG-01D3 with QFN type BlueNRG

Figure 12: Application board EVB (2 layers)

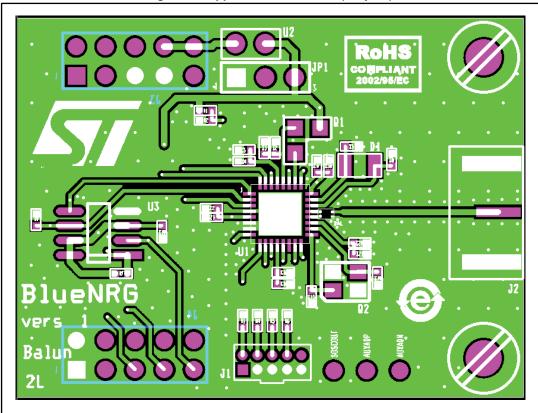
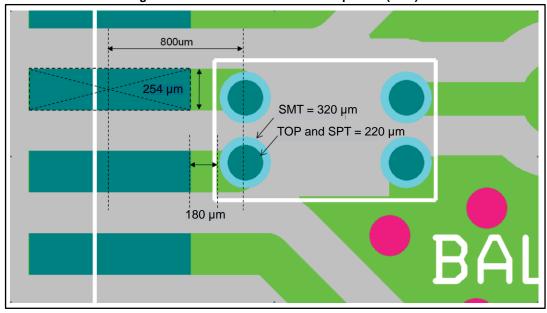


Figure 13: Recommended balun land pattern (EVB)



2.1 BALF-NRG-01D3 measurements on QFN EVB

Figure 14: Harmonics

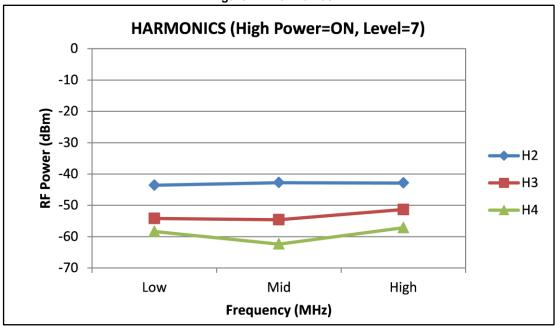


Figure 15: Sensitivity

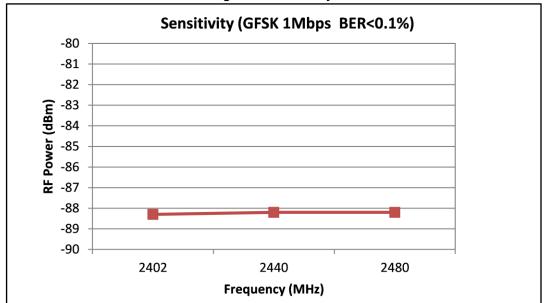
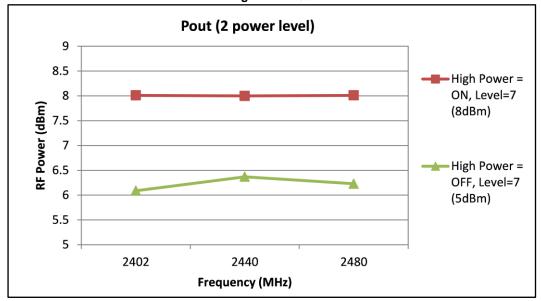


Figure 16: Pout



3 BALF-NRG-01D3 with WLCSP type BlueNRG

Figure 17: Recommended balun land pattern (WLCSP)

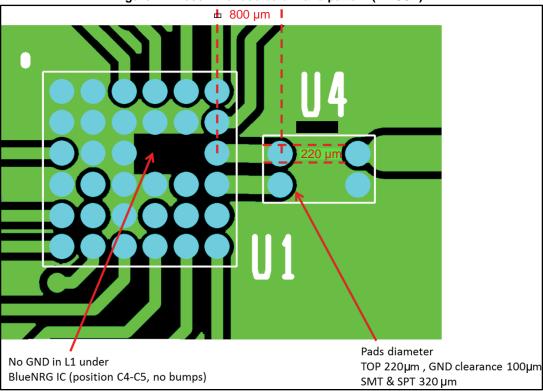


Figure 18: PCB stack-up recommendation



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3.1 BALF-NRG-01D3 measurements on WLCSP EVB

Figure 19: Harmonics

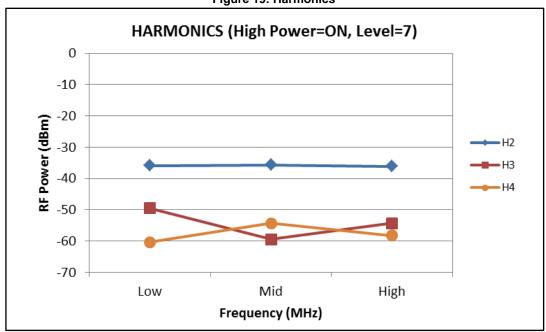


Figure 20: Sensitivity

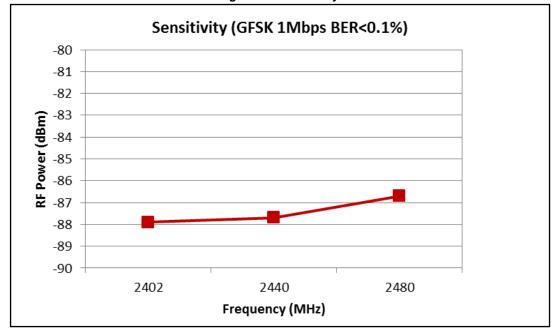
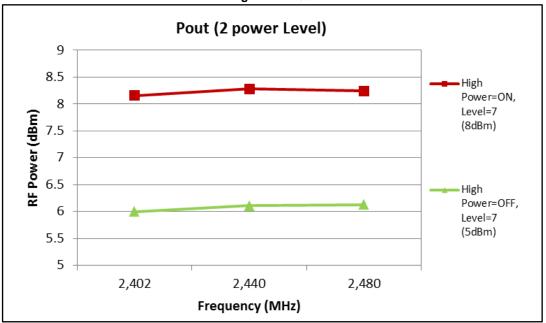


Figure 21: Pout



BALF-NRG-01D3 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

- Epoxy meets UL94, V0
- Lead-free package

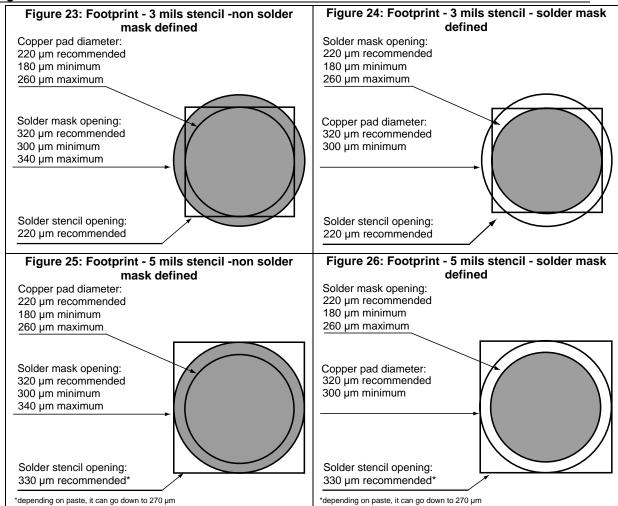
4.1 Flip-Chip 4 bumps package information

Figure 22: Flip-Chip 4 bumps package outline

Table 4: Flip-Chip 5 bumps dimensions

Damana dan		Dimesions (in mm)	
Parameter	Min.	Тур.	Max.
А	0.580	0.630	0.680
A1	0.180	0.205	0.230
A2	0.380	0.400	0.420
b	0.230	0.255	0.280
D	1.375	1.400	1.425
D1	0.990	1.000	1.010
Е	0.825	0.850	0.875
E1	0.390	0.400	0.410
SE		0.200	
fD	0.170	0.200	0.230
fE	0.195	0.225	0.255
ccc			0.050
Ø		0.025	

Package information BALF-NRG-01D3



BALF-NRG-01D3 Package information

4.2 Flip-chip 4 bumps packing information

Figure 27: Marking

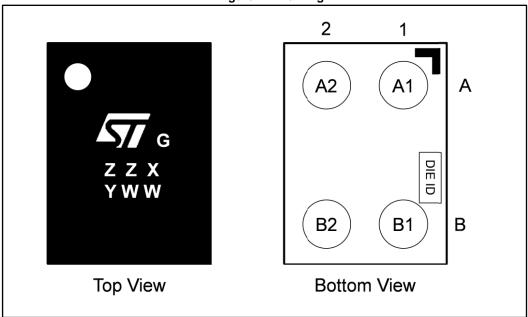
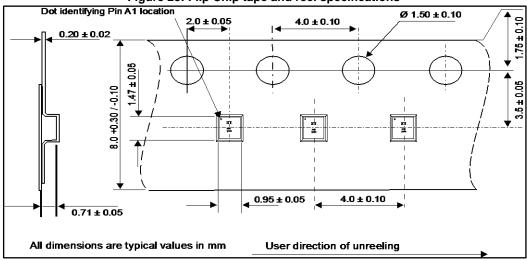


Table 5: Document revision history

Ball	Name	Description	
A1	ANT	Antenna connection	
A2	GND	Ground	
B1	Rx_P	Balun receive positive output	
B2	Rx_N	Balun receive negative output	

Figure 28: Flip Chip tape and reel specifications





More packing information is available in the application note:

• AN2348 Flip-Chip: "Package description and recommendations for use"

Ordering information BALF-NRG-01D3

5 Ordering information

Table 6: Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
BALF-NRG-01D3	SV	Flip-Chip package (4 bumps)	1.35 mg	5000	Tape and reel (7")

6 Revision history

Table 7: Document revision history

Date	Revision	Changes	
17-Jun-2014	1	Initial release.	
17-Jul-2014	2	Updated Figure 13, Figure 17, Figure 22 and package view on cover page. Corrected typo error on Table 2.	
18-Aug-2014	3	Updated title and description in cover page.	
29-Sep-2015	4	Updated Figure 22. Added Figure 25 and Figure 26. Reformatted to current standards.	
04-May-2017	5	Updated Figure 2: "Application schematic with WLCSP type BlueNRG".	

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